In the Specification:

Please add a new section directly before the "Technical Field" as follows:

CROSS REFERENCE TO RELATED APPLICATION

This application is a divisional application of United States Patent Application
No. 09/644,766 entitled "STACKED MICROELECTRONIC DIES AND METHODS FOR
STACKING MICROELECTRONIC DIES," filed on August 23, 2000, now Patent No.
, which is incorporated herein by reference in its entirety.